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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Obsolete
Core Processor	CIP-51 8051
Core Size	8-Bit
Speed	25MHz
Connectivity	SMBus (2-Wire/I²C), SPI, UART/USART
Peripherals	Brown-out Detect/Reset, Cap Sense, POR, PWM, WDT
Number of I/O	17
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	24-WFQFN Exposed Pad
Supplier Device Package	24-QFN (4x4)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/c8051f997-gm

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong













Figure 4.2. Idle Mode Current (External CMOS Clock)



5.2.5. Gain Setting

The ADC has gain settings of 1x and 0.5x. In 1x mode, the full scale reading of the ADC is determined directly by V_{REF}. In 0.5x mode, the full-scale reading of the ADC occurs when the input voltage is V_{REF} x 2. The 0.5x gain setting can be useful to obtain a higher input Voltage range when using a small V_{REF} voltage, or to measure input voltages that are between V_{REF} and V_{DD}. Gain settings for the ADC are controlled by the AMP0GN bit in register ADC0CF.

5.3. 8-Bit Mode

Setting the ADC08BE bit in register ADC0CF to 1 will put the ADC in 8-bit mode. In 8-bit mode, only the 8 MSBs of data are converted, allowing the conversion to be completed in two fewer SAR clock cycles than a 10-bit conversion. This can result in an overall lower power consumption since the system can spend more time in a low power mode. The two LSBs of a conversion are always 00 in this mode, and the ADC0L register will always read back 0x00.

5.4. 12-Bit Mode (C8051F980/6 and C8051F990/6 devices only)

C8051F980/6 and C8051F990/6 devices have an enhanced SAR converter that provides 12-bit resolution while retaining the 10- and 8-bit operating modes of the other devices in the family. When configured for 12-bit conversions, the ADC performs four 10-bit conversions using four different reference voltages and combines the results into a single 12-bit value. Unlike simple averaging techniques, this method provides true 12-bit resolution of AC or DC input signals without depending on noise to provide dithering. The converter also employs a hardware Dynamic Element Matching algorithm that reconfigures the largest elements of the internal DAC for each of the four 10-bit conversions to cancel any matching errors, enabling the converter to achieve 12-bit linearity performance to go along with its 12-bit resolution. For best performance, the Low Power Oscillator should be selected as the system clock source while taking 12-bit ADC measurements.

The 12-bit mode is enabled by setting the AD012BE bit (ADC0AC.7) to logic 1 and configuring Burst Mode for four conversions as described in Section 5.2.3. The conversion can be initiated using any of the methods described in Section 5.2.1, and the 12-bit result will appear in the ADC0H and ADC0L registers. Since the 12-bit result is formed from a combination of four 10-bit results, the maximum output value is $4 \times (1023) = 4092$, rather than the max value of $(2^{12} - 1) = 4095$ that is produced by a traditional 12-bit converter. To further increase resolution, the burst mode repeat value may be configured to any multiple of four conversions. For example, if a repeat value of 16 is selected, the ADC0 output will be a 14-bit number (sum of four 12-bit numbers) with 13 effective bits of resolution.

5.5. Low Power Mode

The SAR converter provides a low power mode that allows a significant reduction in operating current when operating at low SAR clock frequencies. Low power mode is enabled by setting the AD0LPM bit (ADC0PWR.7) to 1. In general, low power mode is recommended when operating with SAR conversion clock frequency at 4 MHz or less. See the Electrical Characteristics chapter for details on power consumption and the maximum clock frequencies allowed in each mode. Setting the Low Power Mode bit reduces the bias currents in both the SAR converter and in the High-Speed Voltage Reference.



SFR Definition 5.3. ADC0AC: ADC0 Accumulator Configuration

Bit	7	6	5	4	3	2	1	0	
Name	AD012BE	AD0AE	Ą	D0SJST[2:0)]	AD0RPT[2:0]			
Туре	R/W	W		R/W			R/W		
Reset	0	0	0	0	0	0	0	0	

SFR Page = 0x0; SFR Address = 0xBA

Bit	Name	Function
7	AD012BE	ADC0 12-Bit Mode Enable. Enables 12-bit Mode on C8051F980/6 and C8051F990/6 devices. 0: 12-bit Mode Disabled. 1: 12-bit Mode Enabled.
6	AD0AE	ADC0 Accumulate Enable. Enables multiple conversions to be accumulated when burst mode is disabled. 0: ADC0H:ADC0L contain the result of the latest conversion when Burst Mode is disabled. 1: ADC0H:ADC0L contain the accumulated conversion results when Burst Mode is disabled. Software must write 0x0000 to ADC0H:ADC0L to clear the accumu- lated result. This bit is write-only. Always reads 0b.
5:3	AD0SJST[2:0]	ADC0 Accumulator Shift and Justify. Specifies the format of data read from ADC0H:ADC0L. 000: Right justified. No shifting applied. 001: Right justified. Shifted right by 1 bit. 010: Right justified. Shifted right by 2 bits. 011: Right justified. Shifted right by 3 bits. 100: Left justified. No shifting applied. All remaining bit combinations are reserved.
2:0	AD0RPT[2:0]	 ADC0 Repeat Count. Selects the number of conversions to perform and accumulate in Burst Mode. This bit field must be set to 000 if Burst Mode is disabled. 000: Perform and Accumulate 1 conversion. 001: Perform and Accumulate 4 conversions. 010: Perform and Accumulate 8 conversions. 011: Perform and Accumulate 16 conversions. 100: Perform and Accumulate 32 conversions. 101: Perform and Accumulate 64 conversions. All remaining bit combinations are reserved.



SFR Definition 5.5. ADC0TK: ADC0 Burst Mode Track Time

Bit	7	6	5	4	3	2	1	0
Name	Reserved			AD0TK[5:0]				
Туре	R	R		R/W				
Reset	0	0	0	1	1	1	1	0

SFR Page = All; SFR Address = 0xBC

Bit	Name	Function
7	Reserved	Read = 0b; Write = Must Write 0b.
6	Unused	Read = 0b; Write = Don't Care.
5:0	AD0TK[5:0]	ADC0 Burst Mode Track Time. Sets the time delay between consecutive conversions performed in Burst Mode. The ADC0 Burst Mode Track time is programmed according to the following equa- tion: $AD0TK = 63 - \left(\frac{Ttrack}{50ns} - 1\right)$ or Ttrack = (64 - AD0TK) 50ns
Notes	If AD0TM is se	et to 1, an additional 3 SAR clock cycles of Track time will be inserted prior to starting the

1. If AD0TM is set to 1, an additional 3 SAR clock cycles of Track time will be inserted prior to starting the conversion.

2. The Burst Mode Track delay is not inserted prior to the first conversion. The required tracking time for the first conversion should be met by the Burst Mode Power-Up Time.



5.7. ADC0 Analog Multiplexer

ADC0 on C8051F99x-C8051F98x has an analog multiplexer, referred to as AMUX0.

AMUX0 selects the positive inputs to the single-ended ADC0. Any of the following may be selected as the positive input: Port I/O pins, the on-chip temperature sensor, Regulated Digital Supply Voltage (Output of VREG0), VDD Supply, or the positive input may be connected to GND. The ADC0 input channels are selected in the ADC0MX register described in SFR Definition 5.12.



Figure 5.7. ADC0 Multiplexer Block Diagram

Important Note About ADC0 Input Configuration: Port pins selected as ADC0 inputs should be configured as analog inputs, and should be skipped by the Digital Crossbar. To configure a Port pin for analog input, set to 0 the corresponding bit in register PnMDIN and disable the digital driver (PnMDOUT = 0 and Port Latch = 1). To force the Crossbar to skip a Port pin, set to 1 the corresponding bit in register PnSKIP. See Section "21. Port Input/Output" on page 215 for more Port I/O configuration details.



5.9. Voltage and Ground Reference Options

The voltage reference MUX is configurable to use an externally connected voltage reference, the internal voltage reference, or one of two power supply voltages (see Figure 5.10). The ground reference MUX allows the ground reference for ADC0 to be selected between the ground pin (GND) or a port pin dedicated to analog ground (P0.1/AGND).

The voltage and ground reference options are configured using the REF0CN SFR described on page 90. Electrical specifications are can be found in the Electrical Specifications Chapter.

Important Note About the V_{REF} and AGND Inputs: Port pins are used as the external V_{REF} and AGND inputs. When using an external voltage reference or the internal precision reference, P0.0/VREF should be configured as an analog input and skipped by the Digital Crossbar. When using AGND as the ground reference to ADC0, P0.1/AGND should be configured as an analog input and skipped by the Digital Crossbar. Refer to Section "21. Port Input/Output" on page 215 for complete Port I/O configuration details. The external reference voltage must be within the range $0 \le V_{REF} \le VDD$ and the external ground reference must be at the same DC voltage potential as GND.



Figure 5.10. Voltage Reference Functional Block Diagram



SFR Definition 7.3. CPT0MX: Comparator0 Input Channel Select

Bit	7	6	5	4	3	2	1	0	
Name		CMX0N[3:0]				CMX0P[3:0]			
Туре	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
Reset	0	1	0	0	0	1	0	0	

SFR Page = 0x0; SFR Address = 0x9F

Bit	Name		Function					
7:4	CMX0N	Comparator0 Selects the ne	Comparator0 Negative Input Selection. Selects the negative input channel for Comparator0.					
		0000:	Reserved	1000:	Reserved			
		0001:	Reserved	1001:	Reserved			
		0010:	Reserved	1010:	Reserved			
		0011:	Reserved	1011:	Reserved			
		0100:	P1.1	1100:	Capacitive Touch Sense Compare			
		0101:	Reserved	1101:	VDD divided by 2			
		0110:	Reserved	1110:	Digital Supply Voltage			
		0111:	Reserved	1111:	Ground			
3:0	CMX0P	Comparator0	Positive Input Selection.					
		Selects the po	sitive input channel for Com	parator0.				
		0000:	Reserved	1000:	Reserved			
		0001:	Reserved	1001:	Reserved			
		0010:	Reserved	1010:	Reserved			
		0011:	Reserved	1011:	Reserved			
		0100:	P1.0	1100:	Capacitive Touch Sense Compare			
		0101:	Reserved	1101:	VDD divided by 2			
		0110:	Reserved	1110:	VDD Supply Voltage			
		0111:	Reserved	1111:	VDD Supply Voltage			



8.8. Automatic Scanning (Method 1—CS0SMEN = 0)

CS0 can be configured to automatically scan a sequence of contiguous CS0 input channels by configuring and enabling auto-scan. Using auto-scan with the CS0 comparator interrupt enabled allows a system to detect a change in measured capacitance without requiring any additional dedicated MCU resources.

Auto-scan is enabled by setting the CS0 start-of-conversion bits (CS0CF6:4) to 111b. After enabling autoscan, the starting and ending channels should be set to appropriate values in CS0SS and CS0SE, respectively. Writing to CS0SS when auto-scan is enabled will cause the value written to CS0SS to be copied into CS0MX. After being enabled, writing a 1 to CS0BUSY will start auto-scan conversions. When auto-scan completes the number of conversions defined in the CS0 accumulator bits (CS0CF1:0), autoscan configures CS0MX to the next sequential port pin configured as an analog input and begins a conversion on that channel. All other pins between CS0SS and CS0SE which are set as analog inputs are grounded during the conversion. This scan sequence continues until CS0MX reaches the ending input channel value defined in CS0SE. After one or more conversions have been taken at this channel, autoscan configures CS0MX back to the starting input channel. For an example system configured to use autoscan, please see Figure "8.2 Auto-Scan Example" on page 103.

Note: Auto-scan attempts one conversion on a CS0MX channel regardless of whether that channel's port pin has been configured as an analog input. Auto-scan will also complete the current rotation when the device is halted for debugging.

If auto-scan is enabled when the device enters suspend mode, auto-scan will remain enabled and running. This feature allows the device to wake from suspend through CS0 greater-than comparator event on any configured capacitive sense input included in the auto-scan sequence of inputs.



Figure 8.2. Auto-Scan Example



SFR Definition 8.7. CS0SS: Capacitive Sense Auto-Sca	n Start Channel
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Bit	7	6	5	4	3	2	1	0
Name				CS0SS[4:0]				
Туре	R	R	R	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Page = 0x0; SFR Address = 0xDD

Bit	Name	Description
7:5	Unused	Read = 000b; Write = Don't care
4:0	CS0SS[4:0]	Starting Channel for Auto-Scan.
		Sets the first CS0 channel to be selected by the mux for Capacitive Sense conver- sion when auto-scan is enabled and active. All channels detailed in CS0MX SFR Definition 8.15 are possible choices for this register. When auto-scan is enabled, a write to CS0SS will also update CS0MX.

SFR Definition 8.8. CS0SE: Capacitive Sense Auto-Scan End Channel

Bit	7	6	5	4	3	2	1	0
Name				CS0SE[4:0]				
Туре	R	R	R	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Page = 0x0; SFR Address = 0xDE

Bit	Name	Description
7:5	Unused	Read = 000b; Write = Don't care
4:0	CS0SE[4:0]	Ending Channel for Auto-Scan.
		Sets the last CS0 channel to be selected by the mux for Capacitive Sense conver- sion when auto-scan is enabled and active. All channels detailed in CS0MX SFR Definition 8.15 are possible choices for this register.



13.5. Interrupt Register Descriptions

The SFRs used to enable the interrupt sources and set their priority level are described in the following register descriptions. Refer to the data sheet section associated with a particular on-chip peripheral for information regarding valid interrupt conditions for the peripheral and the behavior of its interrupt-pending flag(s).



14.3. Security Options

The CIP-51 provides security options to protect the Flash memory from inadvertent modification by software as well as to prevent the viewing of proprietary program code and constants. The Program Store Write Enable (bit PSWE in register PSCTL) and the Program Store Erase Enable (bit PSEE in register PSCTL) bits protect the Flash memory from accidental modification by software. PSWE must be explicitly set to 1 before software can modify the Flash memory; both PSWE and PSEE must be set to 1 before software can erase Flash memory. Additional security features prevent proprietary program code and data constants from being read or altered across the C2 interface.

A Security Lock Byte located at the last byte of Flash user space offers protection of the Flash program memory from access (reads, writes, or erases) by unprotected code or the C2 interface. See **Section "10. Memory Organization" on page 128** for the location of the security byte. The Flash security mechanism allows the user to lock n 512-byte Flash pages, starting at page 0 (addresses 0x0000 to 0x01FF), where n is the 1s complement number represented by the Security Lock Byte. The page containing the Flash Security Lock Byte is unlocked when no other Flash pages are locked (all bits of the Lock Byte is 0).

Security Lock Byte:	1111 1011b
ones Complement:	0000 0100b
Flash pages locked:	5 (First four Flash pages + Lock Byte Page)



Figure 14.1. Flash Program Memory Map (8 kB and smaller devices)

The level of Flash security depends on the Flash access method. The three Flash access methods that can be restricted are reads, writes, and erases from the C2 debug interface, user firmware executing on unlocked pages, and user firmware executing on locked pages. Table 14.1 summarizes the Flash security features of the C8051F99x-C8051F98x devices.



19.3.3. External Capacitor Mode

If a capacitor is used as the external oscillator, the circuit should be configured as shown in Figure 19.1, Option 3. The capacitor should be added to XTAL2, and XTAL2 should be configured for analog I/O with the digital output drivers disabled. XTAL1 is not affected in RC mode.

The capacitor should be no greater than 100 pF; however, for very small capacitors, the total capacitance may be dominated by parasitic capacitance in the PCB layout. The oscillation frequency and the required External Oscillator Frequency Control value (XFCN) in the OSCXCN Register can be determined by the following equation:

$$f = \frac{\mathrm{KF}}{\mathrm{C} \times \mathrm{V}_{\mathrm{DD}}}$$

where

f = frequency of clock in MHzR = pull-up resistor value in $k\Omega$ V_{DD} = power supply voltage in VoltsC = capacitor value on the XTAL2 pin in pF

Below is an example of selecting the capacitor and finding the frequency of oscillation Assume $V_{DD} = 3.0 \text{ V}$ and f = 150 kHz:

$$f = \frac{\text{KF}}{\text{C} \times \text{V}_{\text{DD}}}$$

 $0.150 \text{ MHz} = \frac{\text{KF}}{\text{C} \times 3.0}$

Since a frequency of roughly 150 kHz is desired, select the K Factor from Table 19.2 as KF = 22:

$$0.150 \text{ MHz} = \frac{22}{\text{C} \times 3.0 \text{ V}}$$

 $C = \frac{22}{0.150 \text{ MHz} \times 3.0 \text{ V}}$

C = 48.8 pF

Therefore, the XFCN value to use in this example is 011 and C is approximately 50 pF.

The recommended startup procedure for C mode is the same as RC mode.

19.3.4. External CMOS Clock Mode

If an external CMOS clock is used as the external oscillator, the clock should be directly routed into XTAL2. The XTAL2 pin should be configured as a digital input. XTAL1 is not used in external CMOS clock mode.

The external oscillator valid detector will always return zero when the external oscillator is configured to External CMOS Clock mode.



19.4. Special Function Registers for Selecting and Configuring the System Clock

The clocking sources on C8051F99x-C8051F98x devices are enabled and configured using the OSCICN, OSCICL, OSCXCN and the SmaRTClock internal registers. See Section "20. SmaRTClock (Real Time Clock)" on page 197 for SmaRTClock register descriptions. The system clock source for the MCU can be selected using the CLKSEL register. To minimize active mode current, the oneshot timer which sets Flash read time should by bypassed when the system clock is greater than 10 MHz. See the FLSCL register description for details.

The clock selected as the system clock can be divided by 1, 2, 4, 8, 16, 32, 64, or 128. When switching between two clock divide values, the transition may take up to 128 cycles of the undivided clock source. The CLKRDY flag can be polled to determine when the new clock divide value has been applied. The clock divider must be set to "divide by 1" when entering Suspend or Sleep Mode.

The system clock source may also be switched on-the-fly. The switchover takes effect after one clock period of the slower oscillator.

SFR Definition 19.1. CLKSEL: Clock Select

Bit	7	6	5	4	3	2	1	0
Name	CLKRDY		CLKDIV[2:0]				CLKSEL[2:0]]
Туре	R		R/W				R/W	
Reset	1	0	0	0	0	0	1	0

SFR Page = All; SFR Address = 0xA9

Bit	Name	Function
7	CLKRDY	System Clock Divider Clock Ready Flag.
		0: The selected clock divide setting has not been applied to the system clock.
		1: The selected clock divide setting has been applied to the system clock.
6:4	CLKDIV[2:0]	System Clock Divider Bits.
		Selects the clock division to be applied to the undivided system clock source.
		000: System clock is divided by 1.
		001: System clock is divided by 2.
		010: System clock is divided by 4.
		011: System clock is divided by 8.
		100: System clock is divided by 16.
		101: System clock is divided by 32.
		110: System clock is divided by 64.
		111: System clock is divided by 128.
3	Unused	Read = 0b. Must Write 0b.
2:0	CLKSEL[2:0]	System Clock Select.
		Selects the oscillator to be used as the undivided system clock source.
		000: Precision Internal Oscillator.
		001: External Oscillator.
		010: Low Power Oscillator divided by 8.
		011: SmaRTClock Oscillator.
		100: Low Power Oscillator.
		All other values reserved.



SFR Definition 19.2. OSCICN: Internal Oscillator Control

Bit	7	6	5	4	3	2	1	0
Name	IOSCEN	IFRDY			Reserv	ved[5:0]		
Туре	R/W	R	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	Varies	Varies	Varies	Varies	Varies	Varies

SFR Page = 0x0; SFR Address = 0xB2

Bit	Name	Function					
7	IOSCEN	Internal Oscillator Enable.					
		0: Internal oscillator disabled.					
		1: Internal oscillator enabled.					
6	IFRDY	Internal Oscillator Frequency Ready Flag.					
		0: Internal oscillator is not running at its programmed frequency.					
		1: Internal oscillator is running at its programmed frequency.					
5:0	Reserved	Must perform read-modify-write.					
Notes:							
1.	1. Read-modify-write operations such as ORL and ANL must be used to set or clear the enable bit of this register.						
2.	OSCBIAS (RE	G0CN.4) must be set to 1 before enabling the precision internal oscillator.					



SFR Definition 20.1. RTC0KEY: SmaRTClock Lock and Key

Bit	7	6	5	4	3	2	1	0
Name	RTC0ST[7:0]							
Туре	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Page = 0x0; SFR Address = 0xAE

Bit	Name	Function
7:0	RTC0ST	SmaRTClock Interface Status.
		Provides lock status when read.
		Read: 0x02: SmaRTClock Interface is unlocked.
		Write: Writes to RTC0KEY have no effect.



22.5. SMBus Transfer Modes

The SMBus interface may be configured to operate as master and/or slave. At any particular time, it will be operating in one of the following four modes: Master Transmitter, Master Receiver, Slave Transmitter, or Slave Receiver. The SMBus interface enters Master Mode any time a START is generated, and remains in Master Mode until it loses an arbitration or generates a STOP. An SMBus interrupt is generated at the end of all SMBus byte frames. Note that the position of the ACK interrupt when operating as a receiver depends on whether hardware ACK generation is enabled. As a receiver, the interrupt for an ACK occurs **before** the ACK with hardware ACK generation disabled, and **after** the ACK when hardware ACK generation is enabled. As a transmitter, interrupts occur **after** the ACK, regardless of whether hardware ACK generation is enabled or not.

22.5.1. Write Sequence (Master)

During a write sequence, an SMBus master writes data to a slave device. The master in this transfer will be a transmitter during the address byte, and a transmitter during all data bytes. The SMBus interface generates the START condition and transmits the first byte containing the address of the target slave and the data direction bit. In this case the data direction bit (R/W) will be logic 0 (WRITE). The master then transmits one or more bytes of serial data. After each byte is transmitted, an acknowledge bit is generated by the slave. The transfer is ended when the STO bit is set and a STOP is generated. Note that the interface will switch to Master Receiver Mode if SMB0DAT is not written following a Master Transmitter interrupt. Figure 22.5 shows a typical master write sequence. Two transmit data bytes are shown, though any number of bytes may be transmitted. Notice that all of the 'data byte transferred' interrupts occur **after** the ACK cycle in this mode, regardless of whether hardware ACK generation is enabled.



Figure 22.5. Typical Master Write Sequence



SFR Definition 25.3. TMOD: Timer Mode

Bit	7	6	5	4	3	2	1	0	
Name	GATE1	C/T1	T1M	T1M[1:0] GATE0 C/T0 T0M[1:0]					
Туре	R/W	R/W	R/	W	R/W	R/W	R/	W	
Rese	t 0	0	0	0	0	0	0	0	
SFR Page = 0x0; SFR Address = 0x89									
Bit	Name				Function				
7	GATE1	Timer 1 Ga 0: Timer 1 e 1: Timer 1 e register IT0	te Control. Inabled whei Inabled only ICF (see SF	n TR1 = 1 irr when TR1 = R Definition	respective of = 1 AND INT1 = 13.7).	INT1 logic le	evel. defined by b	it IN1PL in	
6	C/T1	Counter/Tin 0: Timer: Tir 1: Counter:	Counter/Timer 1 Select. 0: Timer: Timer 1 incremented by clock defined by T1M bit in register CKCON. 1: Counter: Timer 1 incremented by high-to-low transitions on external pin (T1).						
5:4	T1M[1:0]	Timer 1 Mo These bits s 00: Mode 0, 01: Mode 1, 10: Mode 2, 11: Mode 3,	Timer 1 Mode Select. These bits select the Timer 1 operation mode. 00: Mode 0, 13-bit Counter/Timer 01: Mode 1, 16-bit Counter/Timer 10: Mode 2, 8-bit Counter/Timer with Auto-Reload 11: Mode 3, Timer 1 Inactive						
3	GATE0	Timer 0 Ga 0: Timer 0 e 1: Timer 0 e register IT0	Timer 0 Gate Control. 0: Timer 0 enabled when TR0 = 1 irrespective of INTO logic level. 1: Timer 0 enabled only when TR0 = 1 AND INTO is active as defined by bit INOPL in register IT01CF (see SFR Definition 13.7).						
2	C/T0	Counter/Tin 0: Timer: Tir 1: Counter:	Counter/Timer 0 Select. 0: Timer: Timer 0 incremented by clock defined by T0M bit in register CKCON. 1: Counter: Timer 0 incremented by high-to-low transitions on external pin (T0).						
1:0	T0M[1:0]	Timer 0 Mo These bits s 00: Mode 0, 01: Mode 1, 10: Mode 2, 11: Mode 3,	Timer 0 Mode Select. These bits select the Timer 0 operation mode. 00: Mode 0, 13-bit Counter/Timer 01: Mode 1, 16-bit Counter/Timer 10: Mode 2, 8-bit Counter/Timer with Auto-Reload 11: Mode 3, Two 8-bit Counter/Timers						



SFR Definition 25.11. TMR2L: Timer 2 Low Byte

Bit	7	6	5	4	3	2	1	0
Name	TMR2L[7:0]							
Туре	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Page = 0x0; SFR Address = 0xCC

Bit	Name	Function
7:0	TMR2L[7:0]	Timer 2 Low Byte.
		In 16-bit mode, the TMR2L register contains the low byte of the 16-bit Timer 2. In 8- bit mode, TMR2L contains the 8-bit low byte timer value.

SFR Definition 25.12. TMR2H Timer 2 High Byte

Bit	7	6	5	4	3	2	1	0
Name	TMR2H[7:0]							
Туре	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Page = 0x0; SFR Address = 0xCD

Bit	Name	Function
7:0	TMR2H[7:0]	Timer 2 Low Byte.
		In 16-bit mode, the TMR2H register contains the high byte of the 16-bit Timer 2. In 8- bit mode, TMR2H contains the 8-bit high byte timer value.



26.5. Register Descriptions for PCA0

Following are detailed descriptions of the special function registers related to the operation of the PCA.

SFR Definition 26.1. PCA0CN: PCA Control

Bit	7	6	5	4	3	2	1	0
Name	CF	CR				CCF2	CCF1	CCF0
Туре	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Page = 0x0; SFR Address = 0xD8; Bit-Addressable

Bit	Name	Function				
7	CF	PCA Counter/Timer Overflow Flag.				
		Set by hardware when the PCA Counter/Timer overflows from 0xFFFF to 0x0000. When the Counter/Timer Overflow (CF) interrupt is enabled, setting this bit causes the CPU to vector to the PCA interrupt service routine. This bit is not automatically cleared by hardware and must be cleared by software.				
6	CR	PCA Counter/Timer Run Control.				
		This bit enables/disables the PCA Counter/Timer.				
		0: PCA Counter/Timer disabled.				
		1: PCA Counter/Timer enabled.				
5:3	Unused	Read = 000b, Write = don't care.				
2:0	CCF[2:0]	PCA Module n Capture/Compare Flag.				
		These bits are set by hardware when a match or capture occurs in the associated PCA Module n. When the CCFn interrupt is enabled, setting this bit causes the CPU to vector to the PCA interrupt service routine. This bit is not automatically cleared by hardware and must be cleared by software.				

